Standard Product Reference Sheet

VCHB1104LSE-TR



Features

Package	PLCC-2 Type, Outer Dimension 3.5 x 2.8 x 1.9mm(L x W x H)
Product features	・Wide range temperature applicable product ・High reliability (for automotive applications and other high-reliability required applications) ・Lead–free soldering compatible ・RoHS compliant

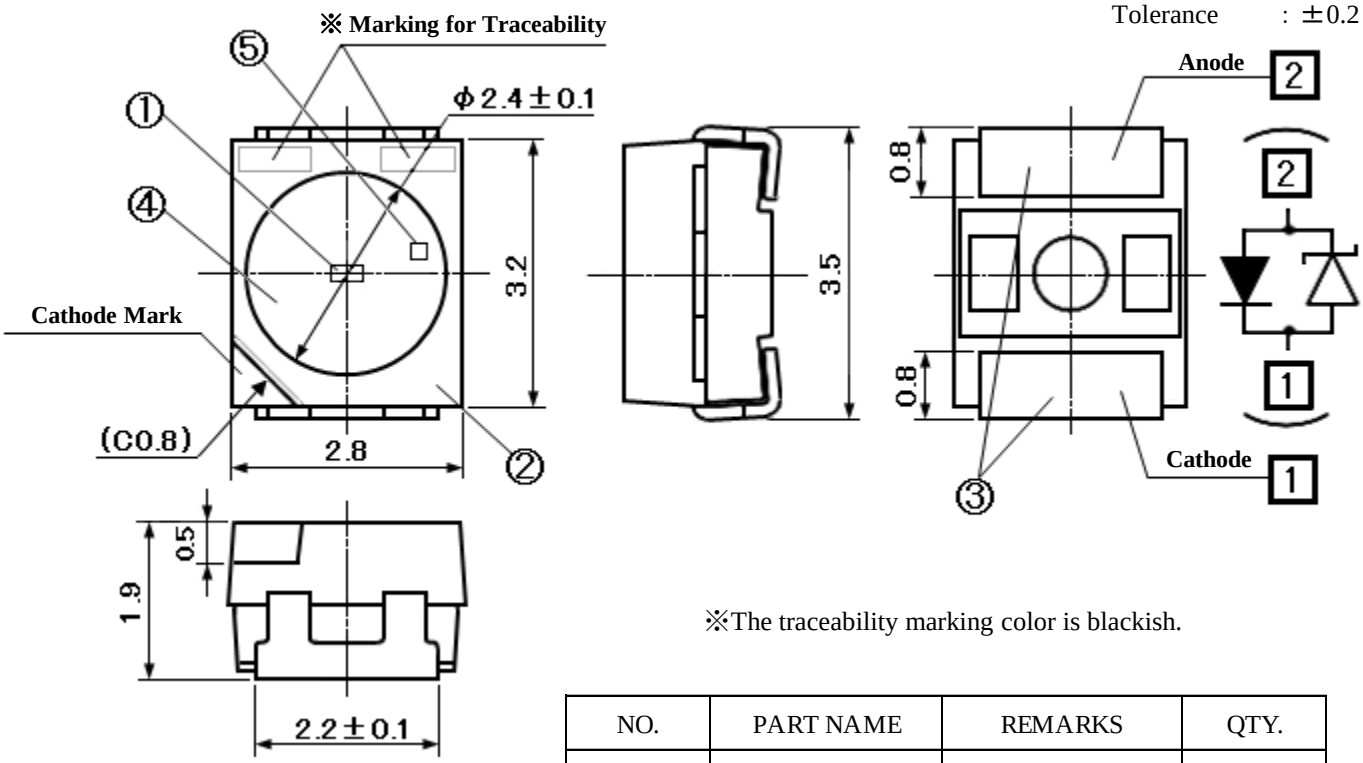
Recommended Applications

・Automotive interior: Switch and buttons , meter panel, car audio , HVAC, other various indicator etc.

Outline Dimensions

VCHB1104LSE-TR

Unit : mm
Weight : 33mg
Tolerance : ±0.2

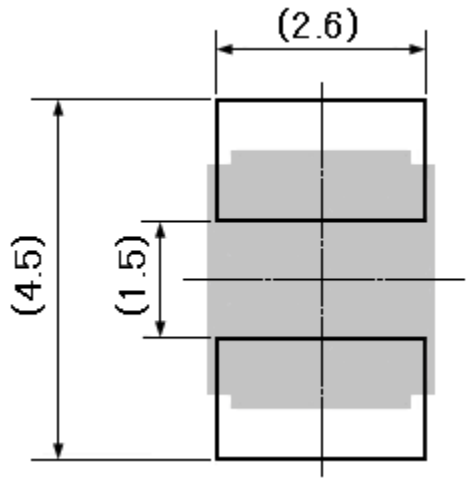


※The traceability marking color is blackish.

NO.	PART NAME	REMARKS	QTY.
①	LED Die	InGaN	1
②	Lamp Housing	White Resin	1
③	Terminal	Au/Pd Plating	2
④	Encapsulant	Silcorne Resin	1
⑤	Protection Diode	Si	1

Recommended Soldering Pad

Unit : mm



【 Product Overview 】

Die Material	InGaN
Emitting Color	Blue
Resin Color (Emitting Area)	Water Clear
Resin Color (Lamp Housing)	White

【 Absolute Maximum Ratings 】

(Ta=25℃)

ITEM	SYMBOL	MAXIMUM RATINGS	UNITS	
Power Dissipation	Pd	120	mW	
Forward Current	I_F	30	mA	
Repetitive Peak Forward Current "10ms,1/10duty"	I_{FRM}	100	mA	
I_F Derate Linearly from "85℃"	ΔI_F	0.86	mA/℃	
I_{FRM} Derate Linearly from "85℃"	ΔI_{FRM}	2.86	mA/℃	
Reverse Current	I_R	70	mA	
Operating Temperature	T_{opr}	−40 ～ +100	℃	
Storage Temperature	T_{stg}	−40 ～ +120	℃	
Junction Temperature	Tj	120	℃	
Electrostatic Discharge Threshold "HBM"	ESD	1,000	V	Note1
Soldering Temperature "Reflow Soldering"	T_{sld}	260	℃	Note2

Note 1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF

Note 2 Please refer to page 8, Soldering Conditions.

【 Thermal Characteristics 】

(Ta=25℃)

ITEM	SYMBOL	TYP.	UNITS	
Thermal Resistance 【Junction - Ambient】	$R_{th(j-a)}$	250	℃/W	Note3
Thermal Resistance 【Junction - Solder point】	$R_{th(j-s)}$	120	℃/W	

Notes3 Rth(j-a) Measurement Condition
Substrate:FR−4（t=1.6mm）
Pattern Size : 16mm²

【 Electro and Optical Characteristics 】

(Ta=25℃)

ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Forward Voltage	V_F	I_F = 20mA	2.9	3.3	3.8	V	Notes4
Luminous Intensity	I_V	I_F = 20mA	82	150	270	mcd	Notes5
Luminous Flux	φ_V	I_F = 20mA	-	0.48	-	lm	
Peak Wavelength	λp	I_F = 20mA	-	458	-	nm	
Dominant Wavelength	λd	I_F = 20mA	460	465	472	nm	Notes6
Spectral Line Half Width	Δλ	I_F = 20mA	-	22	-	nm	
Half Intensity Angle	Δθx	I_F = 20mA	-	120	-	deg.	Notes7
	Δθy		-	120	-		

Notes 4 【Tolerance : ±0.1V】

Notes 5,6 Please refer to following each sorting chart.

Notes7 Viewing Angle at 50% Iv, Δθx ; Housing long side axis, Δθy ; Housing short side axis

【 Sorting Chart for Luminous Intensity and Dominant Wavelength 】

LED's shall be sorted out into the following ranks of Luminous Intensity and Dominant Wavelength.

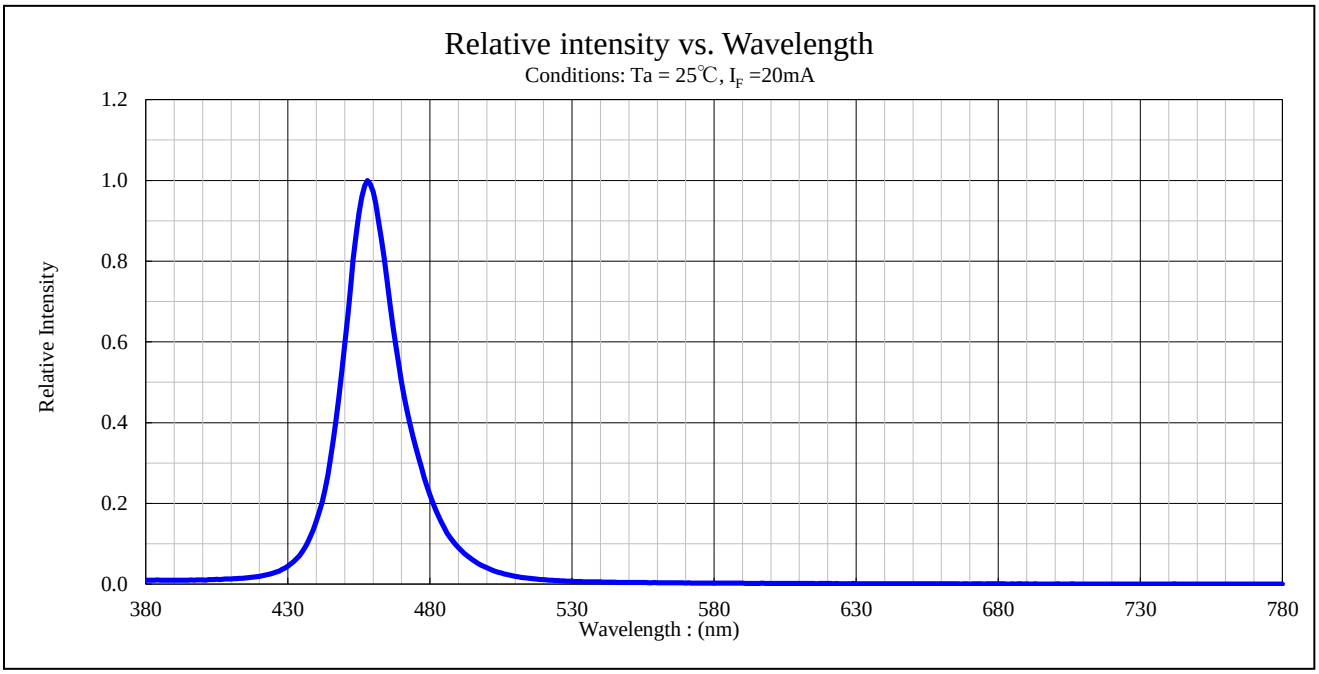
Luminous Intensity (Iv) Rank

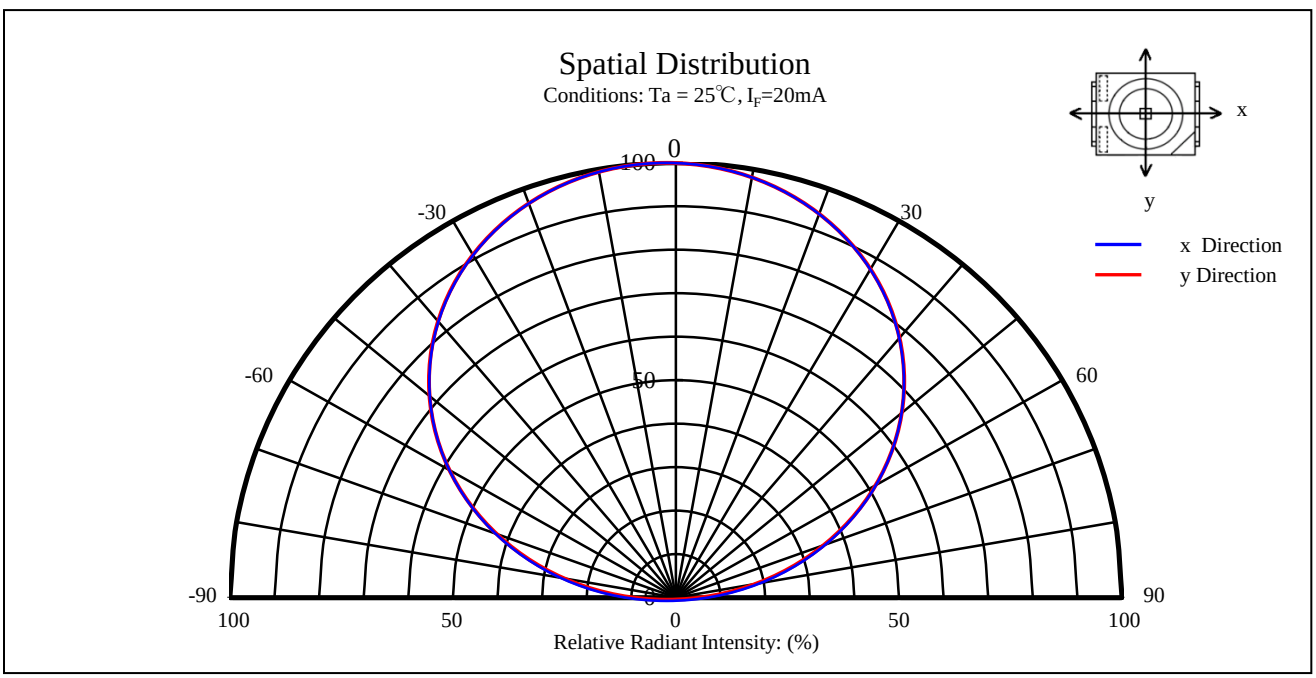
Rank	I_V (mcd)		Conditions
	MIN.	MAX.	
BZ	82	100	Ta=25℃ I_F =20mA
C1	100	120	
C2	120	150	
C3	150	180	
C4	180	220	
C5	220	270	

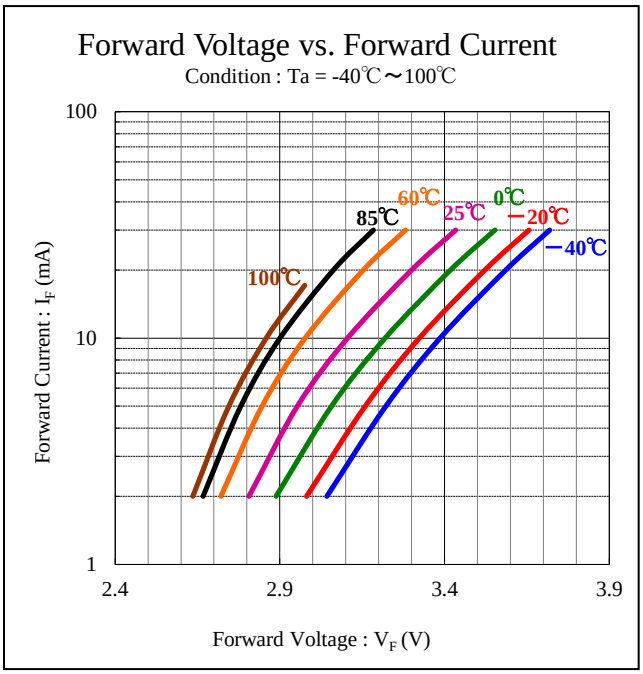
Dominant Wavelength (λd) Rank

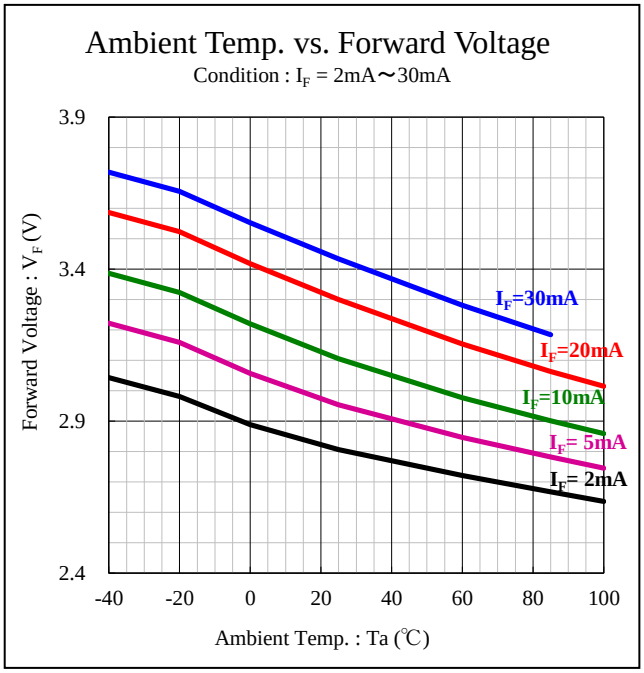
Rank	λd (nm)		Conditions
	MIN.	MAX.	
A	460	464	Ta=25℃ I_F =20mA
B	464	468	
C	468	472	

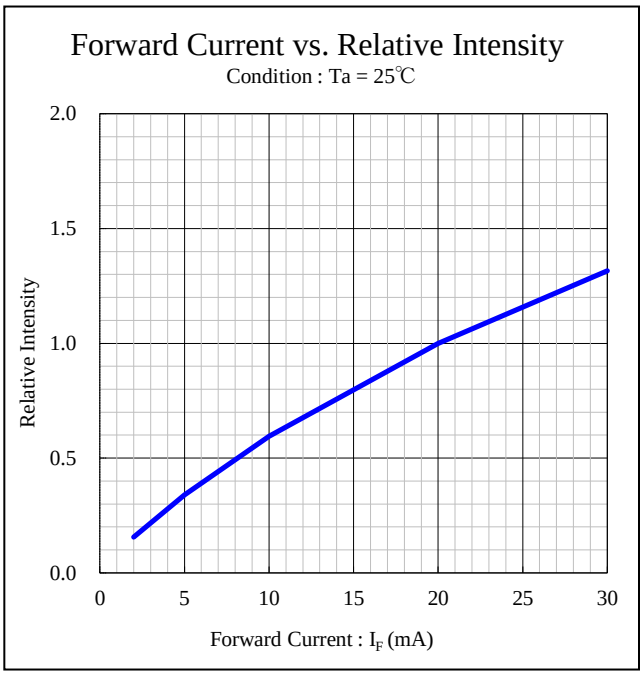
Above the table of Luminous Intensity (Iv) values and Dominant Wavelength (λd) values are the setup value of the selection machine.【Tolerance : Iv ±10%、λd ±1nm】

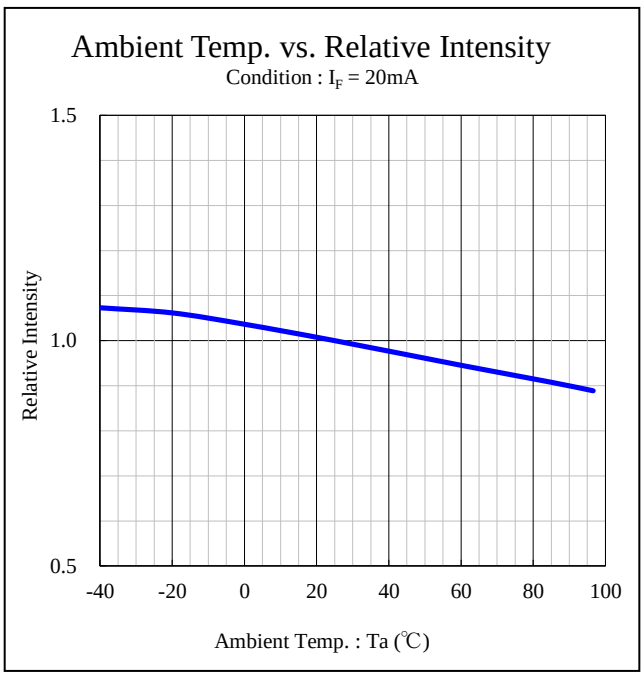

Relative intensity vs. Wavelength
Conditions: Ta = 25℃, I_F =20mA
Relative Intensity
1.2
1.0
0.8
0.6
0.4
0.2
0.0
380
430
480
530
580
630
680
730
780
Wavelength : (nm)


Spatial Distribution
Conditions: Ta = 25℃, I_F=20mA
x
y
x Direction
y Direction
0
30
60
90
-30
-60
-90
100
50
0
50
100
Relative Radiant Intensity: (%)


Forward Voltage vs. Forward Current
Condition : Ta = -40℃～100℃
100
10
1
Forward Current : I_F (mA)
2.4
2.9
3.4
3.9
Forward Voltage : V_F (V)
85℃
60℃
25℃
0℃
−20℃
−40℃
100℃

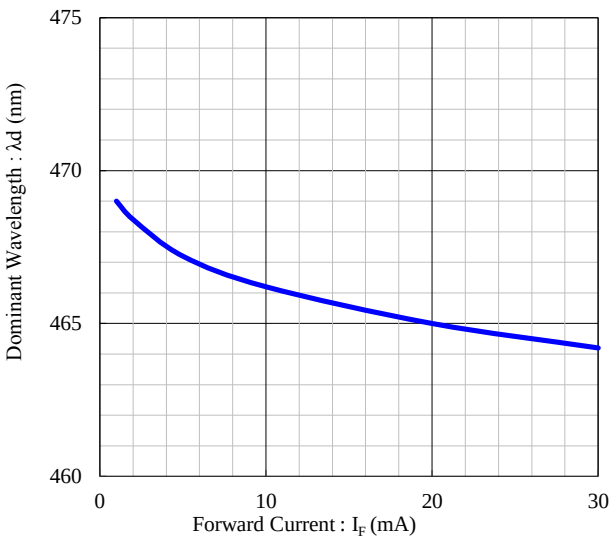

Ambient Temp. vs. Forward Voltage
Condition : I_F = 2mA～30mA
3.9
3.4
2.9
2.4
Forward Voltage : V_F (V)
-40
-20
0
20
40
60
80
100
Ambient Temp. : Ta (℃)
I_F=30mA
I_F=20mA
I_F=10mA
I_F= 5mA
I_F= 2mA


Forward Current vs. Relative Intensity
Condition : Ta = 25℃
2.0
1.5
1.0
0.5
0.0
Relative Intensity
0
5
10
15
20
25
30
Forward Current : I_F (mA)


Ambient Temp. vs. Relative Intensity
Condition : I_F = 20mA
1.5
1.0
0.5
Relative Intensity
-40
-20
0
20
40
60
80
100
Ambient Temp. : Ta (℃)

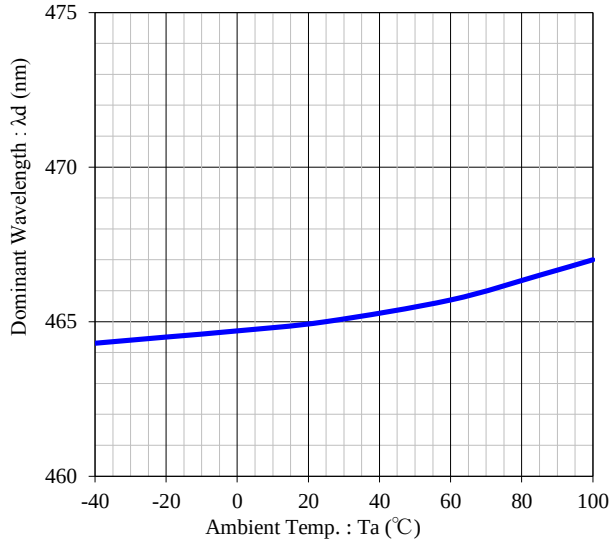
Forward Current vs. Dominant Wavelength

Condition : Ta = 25℃



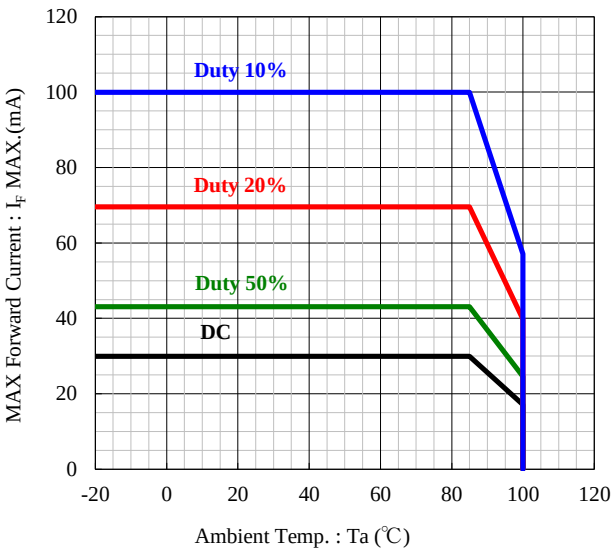
Ambient Temp. vs. Dominant Wavelength

Condition : I_F = 20mA

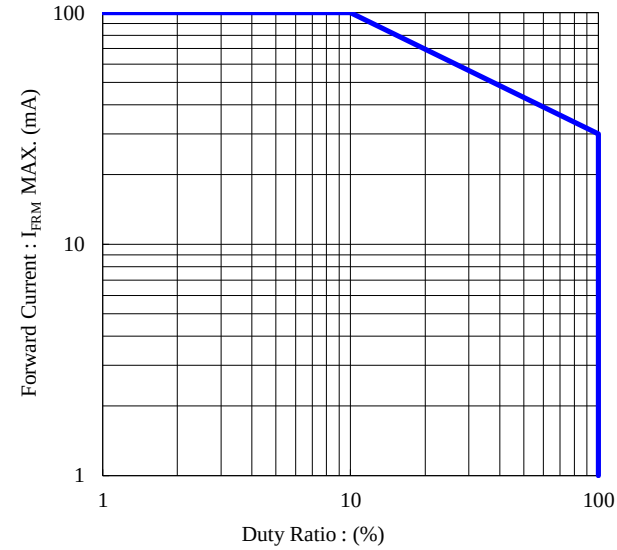


Ambient Temperature vs. Maximum Forward Current

Repeatition Frequency : f≧10Hz



Maximum Forward Current vs. Duty Cycle



【Soldering Precaution】

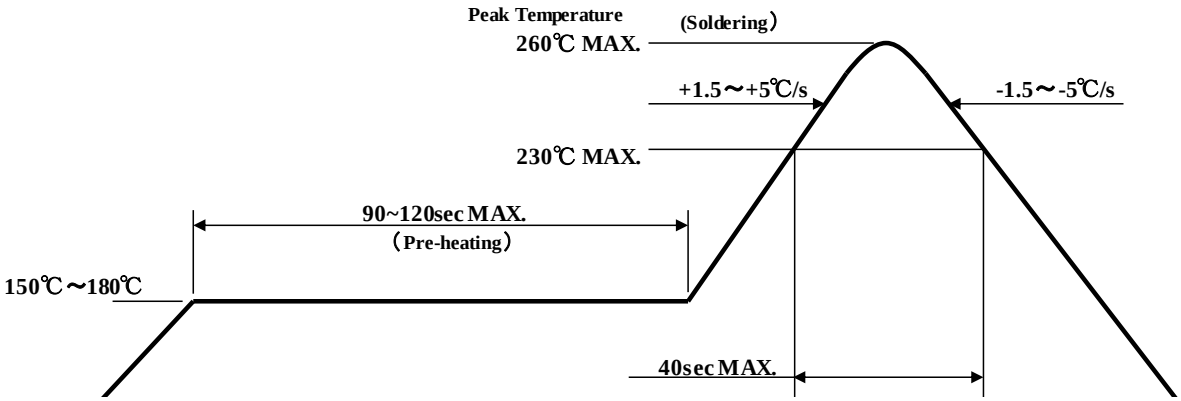
(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).

2. LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.

3. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density.
   Please do not repeat the heating process in Reflow process more than twice.

【Recommended Reflow Soldering Condition】



Notes 1 Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Notes 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touch the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.

5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any type of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

Temperature of Iron Tip	350℃MAX.
Soldering Duration, Time	3sec.Max.,1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended.
《The curing condition, Temperature:150℃Max./Time:120sec.Max.》

7. Flow soldering (dip soldering) is not recommended for this product.

8. lsopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

Chemical	Adaptability
Isopropyl Alcohol	○
Trichloroethylene	×
Chlorothene	×
Acetone	×
Thinner	×

【For Electric Static Discharge (ESD)】

This kind of LED lamp is highly sensitive to surge voltage generated by the On/Off status change and discharges of static electricity through frictions with synthetic materials, which may cause severe damage to the die or undermine its reliability.
Damaged products may experience conditions such as extremely high reverse voltage, or a decrease of forward rise voltage, deteriorating its optical characteristic.
Stanley products are designed to withstand up to 1,000V under the EIAJ ED-4701/300 Test ＃304 (HBM), and are packed with anti-static components. However, the following precautions and measures are vital in ensuring product quality during shipment.
EIAJ ED-4701/300（304/HBM）Electrification model: C=100pF, R2=1.5KΩ

1. Electrification/Static Electricity protection

Stanley recommends the following precautions in order to avoid product (die) damage from static electricity , when an operator and other materials electrified by friction coming in contact with the product.

① Do not place electrified non-conductive materials near the LED product.
Avoid LED products from coming into contact with metallic materials.(Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)

② Avoid a working process which may cause the LED product to rub against other materials.

③ Install ground wires for any equipment, where they can be installed,
with measures to avoid static electricity surges.

④ Prepare a ESD protective area by placing a Conductive Mattress (1MΩ MAX.) and
Ionizer to remove any static electricity.

⑤ Operators should wear a protective wrist-strap.

⑥ Operators should wear conductive work-clothes and shoes.

⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

2. Working Environment

① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.

② Recommended static electricity level in the working environment is 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

【Other Precautions】

1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions

2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.

3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. (Derating of TYP., MAX Forward Voltage, etc.)

4. Please insert Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.

5. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. Also please don't touch lens portion.

6. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.

7. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.

8. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.

9. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).

10. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.

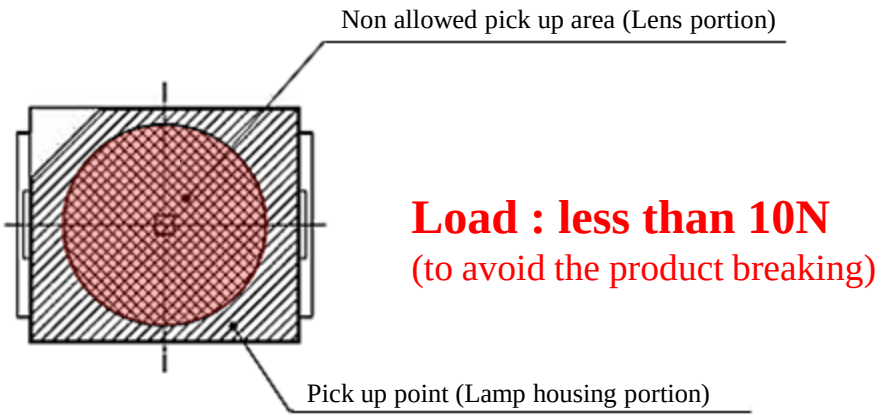
11. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

【Handling Precautions for Product Mounting】

＜Recommendation＞

1. Picking up point with nozzle: Lamp housing of the product (▨ area)
   (Shown below)

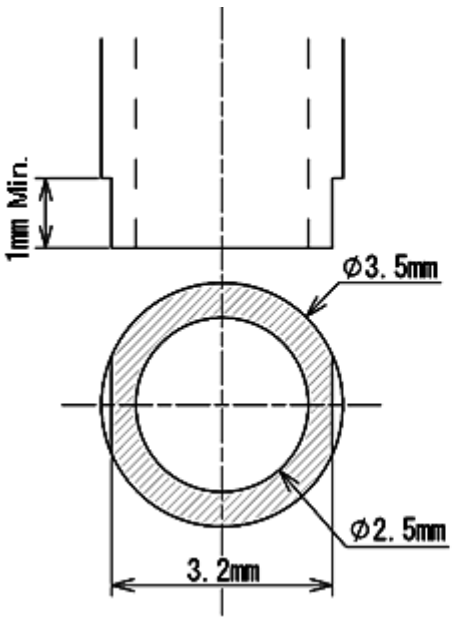
   The picking up point should be within lamp housing portion, because the silicone resin used for the lens is soft.
   (If the nozzle makes contact with the lens, the products might be destroyed)



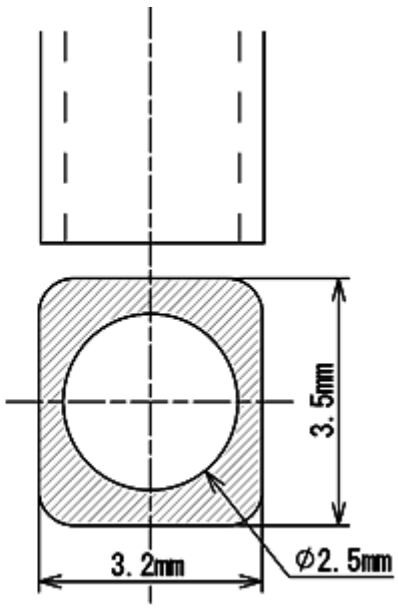
Please adjust the load, the pick up point, the nozzle diameter, etc. before mounting because the over load can cause the breakage of the lamp housing.

2. Recommended Nozzle shape

a



b



※Nozzle with chamfering is recommended

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period】

Temperature	+5～30℃
Humidity	Under 70%

In the case of the package unopened , 6 months under【 Recommended Storage Condition 】.
Please avoid rapid transition from low temp. condition to high temp. condition
and storage in corroding and dusty environment.

【Time elapsed after Package Opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering as is **【maximum 672h】**.
If the device needs to be soldered twice, both soldering operations must be completed within 672h.

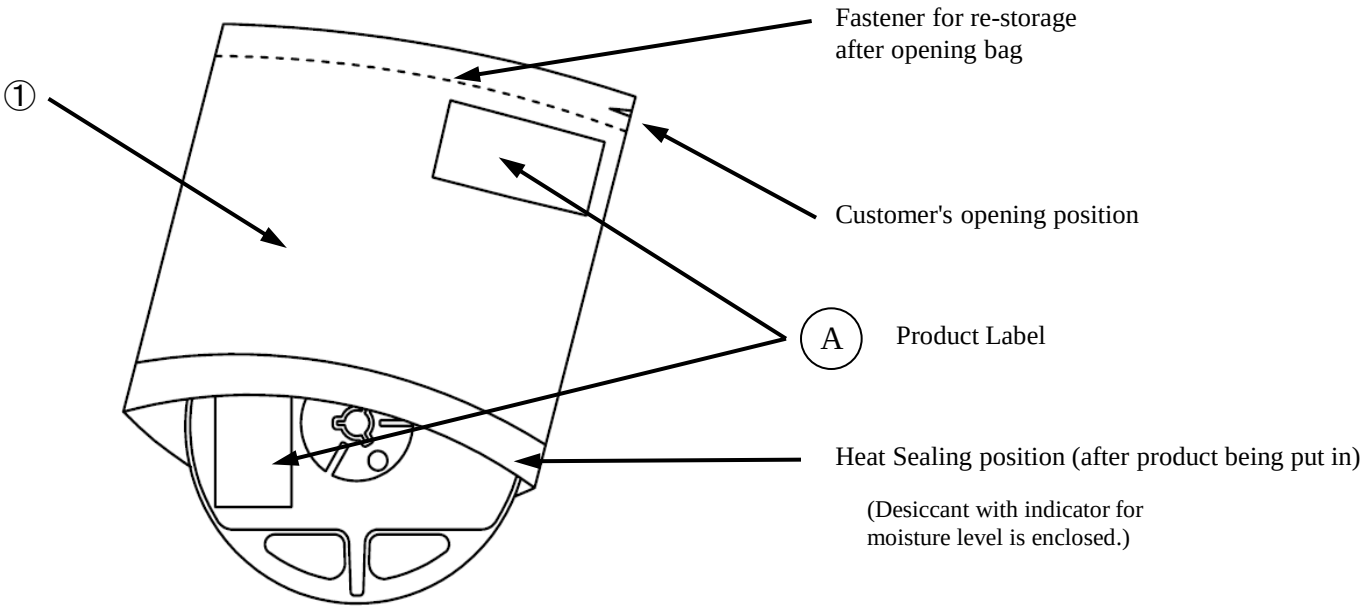
If any components should remain unused, please reseal the package and store them under the conditions described in the【 Recommended Storage Condition 】above.

This product must be required to perform baking process (moisture removal) **for at 48h(MIN.) to 72h(MAX.) at 60±5 degrees Celsius** if following conditions apply.
1.In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 4weeks(672h) after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

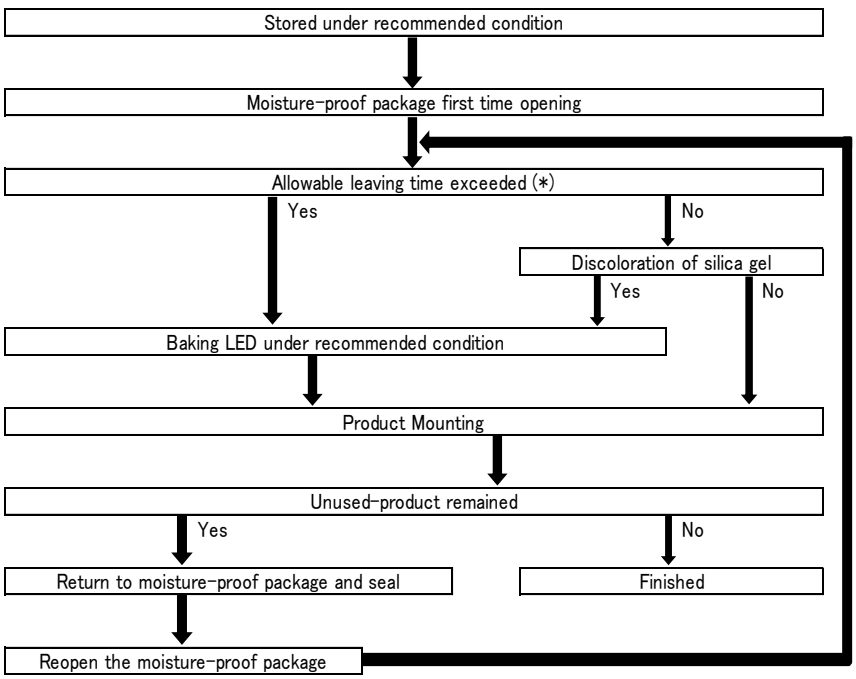
Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

【Moisture-proof Packaging Specification】



NO.	PART NAME	MATELRIAL	REMARKS
①	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.
The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.
When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

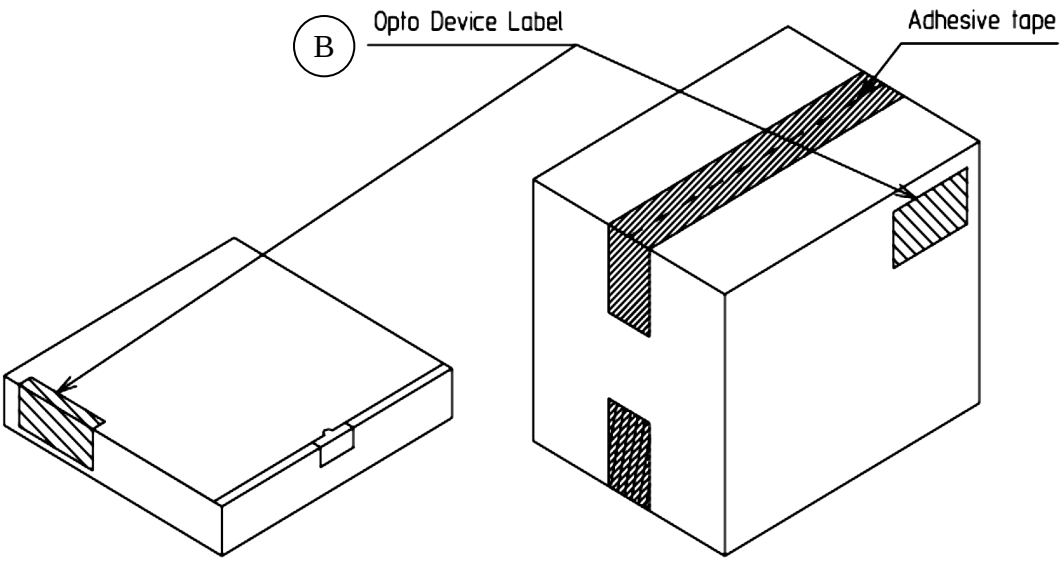
【Packing box】

(RoHS･ELV Compliant)

Box Type	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45 (mm)	3 reels
Type B	310 × 235 × 265 (mm)	15 reels
Type C	440 × 310 × 265 (mm)	30 reels

The above measures are all the reference values.

The box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B,C

Material / box : Cardboard K5AF

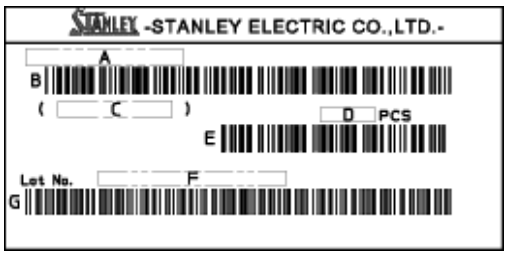
Partition : Cardboard K5AF

NO.	PART NAME	MATELRIAL	REMARKS
②	Packing Box	Corrugated Cardboard	without ESD protection

【Label Specification】

(acc.to JIS-X0503(Code-39)

A Product label



A. Parts number

B. Bar-code for parts number

C. Parts code (In-house identification code for each parts number)

D. Packed parts quantity

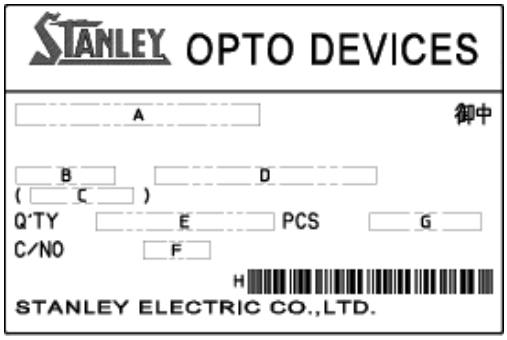
E. Bar-Code for packed parts quantity

F. Lot number & Rank

(refer to Lot Number Notational System for details)

G. Bar-Code for Lot number & Rank

B Opto device label



A. Customer Name

B. Parts Type

C. Parts Code

D. Parts Number

E. Packed Parts Quantity

F. Carton Number

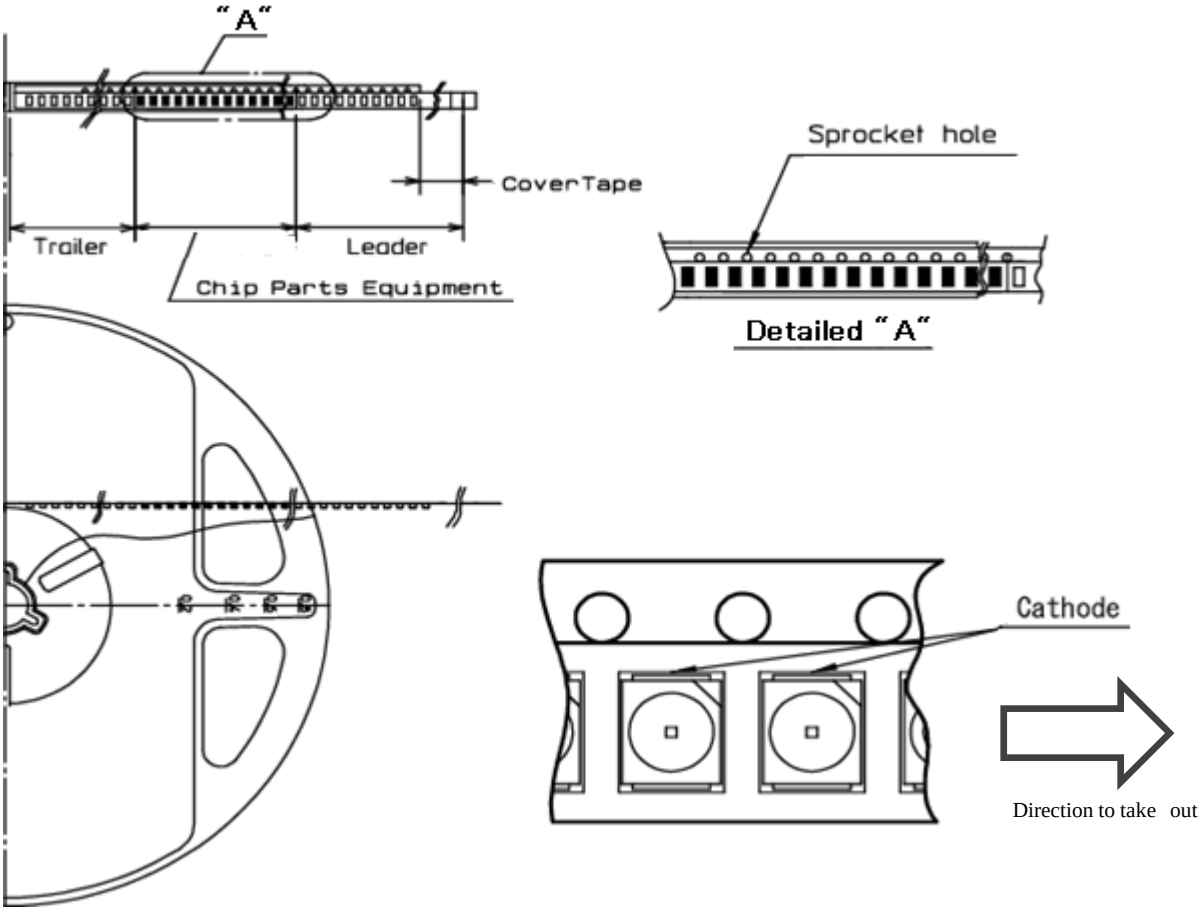
G. Shipping Date

H. Bar-Code for In-house identification Number

<Remarks> Bar-code font : acc.to Code-39(JIX0503)

(acc.to JIS-C0806-03)

【Appearance】



Note

"-TR" means cathode side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 320mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 20 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.

(acc.to JIS-C0806-03)

【Qty. per Reel】

2,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 2,000 parts.
In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1～1.0N (An angle between carrier-tape and cover-tape shall be170 deg.)
Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【Others】

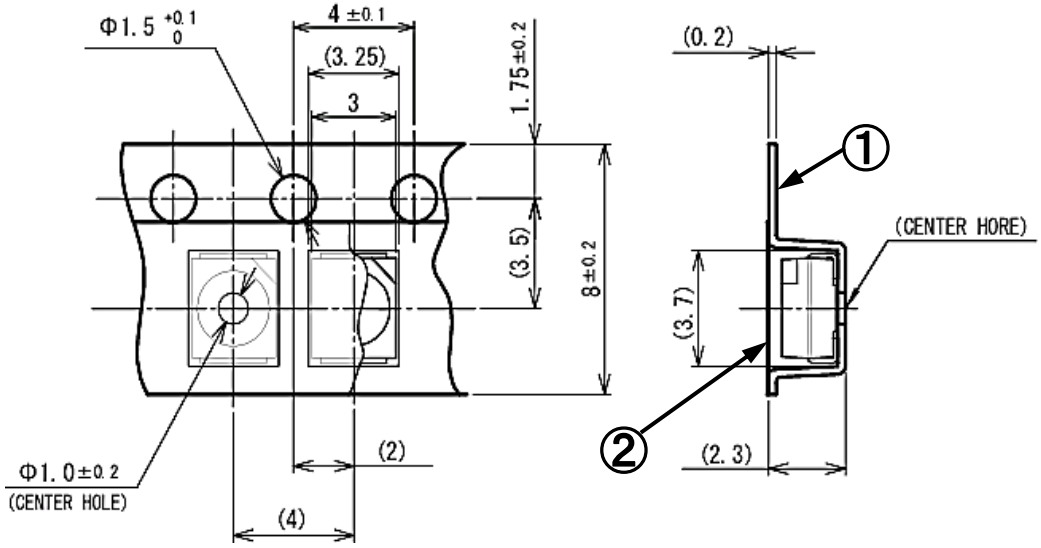
Reversed-orientation, Up-side down placing, side placing and out of spec. parts mixing shall not be held.
Max. qty. of empty pocket per reel shall be defined as follows.

Qty./reel	Max. qty. of empty pocket	Remark
500	1	-
1,000	1	-
1,500	1	-
2,000	2	No continuance

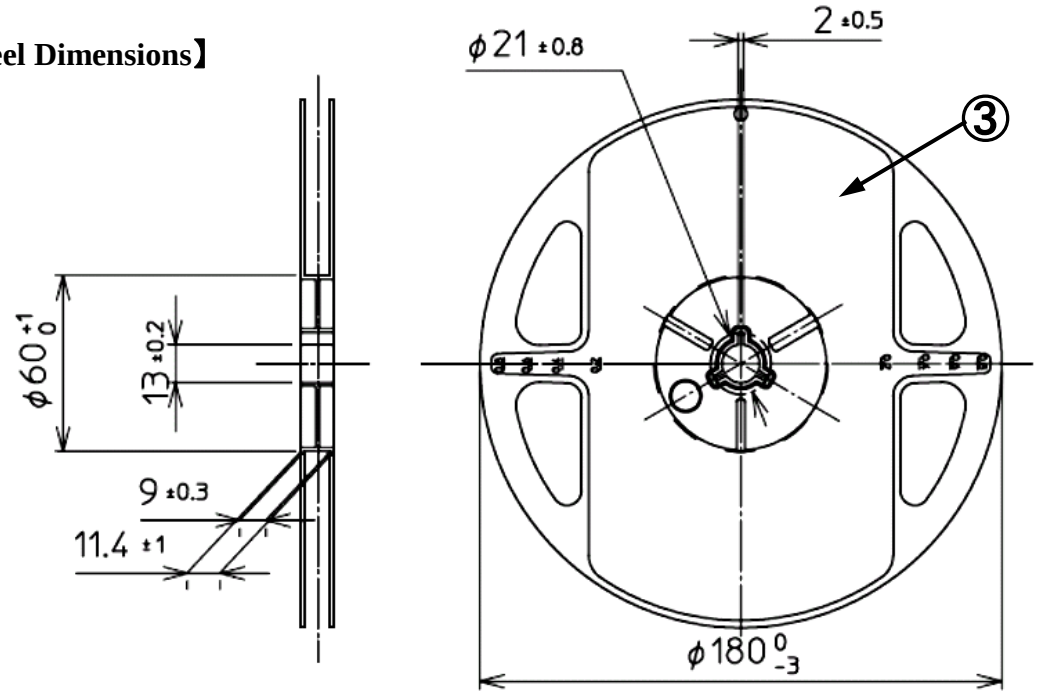
Unit : mm

(acc.to JIS-C0806-03)

【Taping Dimensions】

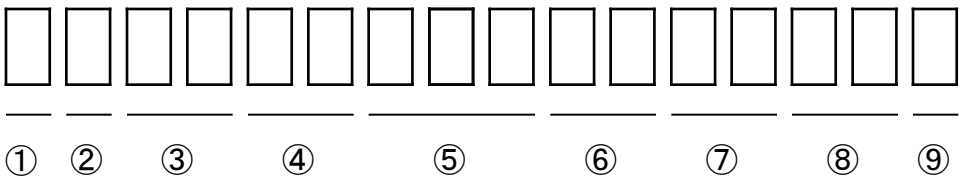


【Reel Dimensions】



NO.	PART NAME	REMARKS
①	Carrier-tape	with ESD protection
②	Cover-tape	with ESD protection
③	Carrier-reel	with ESD protection

Lot Number Notational System VCHB1104LSE-TR



① - 1digit：Production Location (Mark identify alphabet)

② - 1digit：Production Year (Last digit of Production Year 2009→9,2010→0,2011→1,･･･)

③ - 2digits：Production Month (Jan. to Sep. , indicated by 01,02,03,･････)

④ - 2digits：Production Date

⑤ - 3digits：Serial Number

⑥ - 2digits：Tape and Reel following Number

⑦ - 2digits：Luminous Intensity Rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.
If there is no identified intensity rank, "- -" is used to indicate.)

⑧ - 2digits：Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.
If there is no identified intensity rank, "- -" is used to indicate.)

⑨ - 1digit：Option Rank (Stanley normally print "-" to indicate)

Correspondence to RoHS･ELV instruction VCHB1104LSE-TR

This product is in compliance with RoHS･ELV.

Prohibition substance and it's criteria value of RoHS･ELV are as follows.

･RoHS instruction …… Refer to following (1)～(6).

･ELV instruction ……. Refer to following (1)～(4).

	Substance Group Name	Criteria Value
(1)	Lead and its compounds	1,000ppm Max
(2)	Cadmium and its compounds	100ppm Max
(3)	Mercury and its compounds	1,000ppm Max
(4)	Hexavalent chromium	1,000ppm Max
(5)	PBB	1,000ppm Max
(6)	PBDE	1,000ppm Max

1. Reliability Testing Result

Test Item	Reference Standard	Test Condition		Failure
Room Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=25℃ I_F=30mA	1,000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85℃ I_F=30mA	1,000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701/100(101)	Ta=-40℃ I_F=30mA	1,000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701/100(102)	Ta=60℃ 90% I_F=30mA	1,000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701/200(201)	Ta=120℃	1,000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701/200(202)	Ta=-40℃	1,000h	0 / 20
Wet High Temperature Storage Life	EIAJ ED-4701/100(101)	Ta=60℃ Rh=90%	1,000h	0 / 20
Thermal Shock	EIAJ ED-4701/100(105)	Ta=-40℃ ～120℃ (each 15min)	1,000cycles	0 / 20
Thermal Shock Operating	EIAJ ED-4701/100(105)	Ta=-40℃(OFF) ～85℃(I_F=30mA ON) (each 15min)	1,000cycles	0 / 20
Cycled Temperature Humidity Operating Life	EIAJ ED-4701/200(203)	Ta=-30℃ (2h) ～ 80℃ 95% (2h) 8h / cycle I_F=30mA 5min on-off	30 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701/300(301)	Moisture Soak：30℃ 70% 4weeks（672h） Preheating ：150～180℃ 90-120sec Soldering：260℃ peak	2 times	0 / 20
Electrostatic Discharge (ESD) ※	EIAJ ED-4701/300(304)	C=100pF R2=1.5kΩ ±2,000V	3 times of each polarity	0 / 10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s2(10G) 100～2,000Hz 20min XYZ direction	Each direction	0 / 10

※Reference Test

2. Failure Criteria

Item	Symbol	Condition	Failure Criteria
Luminous Intensity	I_V	I_F=20mA	Testing Min. Value ＜ Standard Min. Value × 0.5
Forward Voltage	V_F	I_F=20mA	Testing Max. Value ≧ Standard Max. Value × 1.2
Cosmetic Appearance	-	-	Notable discoloration, deformation and cracking

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1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.

3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.

4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).

   The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.

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7) The most updated edition of this data sheet can be obtained from the address below:
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